2.5V Drive Nch+SBD MOS FET QS5U13

●Structure

Silicon N-channel MOSFET Schottky Barrier DIODE

● Features

- 1) The QS5U13 combines Nch MOSFET with a Schottky barrier diode in a single TSMT5 package.
- 2) Low on-state resistance with fast switching.
- 3) Low voltage drive (2.5V).
- 4) The Independently connected Schottky barrier diode has low forward voltage.

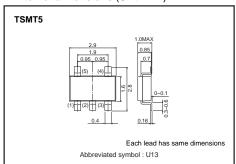
Applications

Load switch, DC / DC conversion

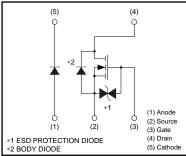
Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
QS5U13		0

●External dimensions (Unit: mm)



●Equivalent circuit



●Absolute maximum ratings (Ta=25°C)

<MOSFET>

Paramete	Symbol	Limits	Unit			
Drain-source voltage	Voss	30	V			
Gate-source voltage	V _{GSS}	12	V			
Droin ourrent	Continuous	I _D	±2.0	A		
Drain current	Pulsed	I _{DP} *1	±8.0	Α		
Source current	Continuous	Is	0.8	A		
(Body diode)	Pulsed	Isp *1	3.2	Α		
Channel temperature		Tch	150	°C		
Power dissipation		P _D *3	0.9	W/ELEMENT		
<di></di>						
Repetitive peak reverse voltage		V _{RM}	30	V		
Reverse voltage	VR	20	V			
Forward current	lF	0.5	Α			
Forward current surge pe	Irsm *2	2.0	A			
Junction temperature	Tj	150	°C			
Power dissipation	Pp *3	0.7	W/ELEMENT			
<mosfet and="" di=""></mosfet>						
Total power dissipation	P _D *3	1.25	W / TOTAL			
Range of Storage tempe	Tstg	-55 to +150	°C			
#1 Duc10us Duty avaloc19/ #1	COUT TOUC #2 Mour	ntod on a coromic board				

^{*1} Pw≤10μs, Duty cycle≤1% *2 60Hz-1cyc. *3 Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	-	-	10	μА	V _{GS} =12V / V _{DS} =0V
Drain-source breakdown voltage	V _(BR) DSS	30	-	-	V	I _D =1mA, / V _{GS} =0V
Zero gate voltage drain current	IDSS	_	_	1	μΑ	V _{DS} =30V / V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	0.5	_	1.5	V	V _{DS} =10V / I _D =1mA
Otatia dania anno an atata		-	71	100	mΩ	In=2.0A, Vgs=4.5V
Static drain-source on-state resistance	RDS (on)*	-	76	107	mΩ	In=2.0A, Vgs=4V
- Colotario		-	110	154	mΩ	In=2.0A, Vgs=2.5V
Forward transfer admittance	Yfs	1.5	_	_	S	V _{DS} =10V, I _D =2.0A
Input capacitance	Ciss	-	175	_	pF	V _{DS} =10V
Output capacitance	Coss	-	50	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	25	_	pF	f=1MHz
Turn-on delay time	t d (on) *	-	8	_	ns	ID=1.0A
Rise time	tr *	-	10	_	ns	VDD≒15V VGS=4.5V
Turn-off delay time	t _{d (off)} *	-	21	_	ns	$R_{i}=15\Omega$
Fall time	t _f *	-	8	_	ns	R _G =10Ω
Total gate charge	Qg *	-	2.8	3.9	nC	V _{DD} ≒15V
Gate-source charge	Q _{gs} *	-	0.6	-	nC	V _{GS} =4.5V
Gate-drain charge	Q _{gd} *	-	0.8	_	nC	I _D =2.0A

^{*}Pulsed

<Body diode (source-drain)>

Though diode (Source drain)						
Forward voltage	Vsp *	-	-	1.2	V	Is=3.2A / Vgs=0V

^{*} Pulsed

<	D	i>

Forward voltage	VF	_	-	0.36	V	I _F =0.1A
		-	-	0.47	V	I _F =0.5A
Reverse current	l _R	_	_	100	цΑ	V _R =20V



•Electrical characteristic curves

<MOSFET>

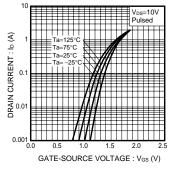


Fig.1 Typical Transfer Characteristics

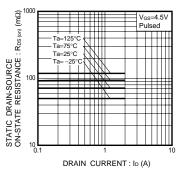


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

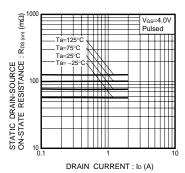


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

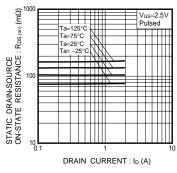


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

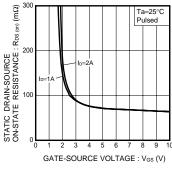


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

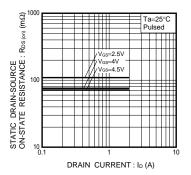


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

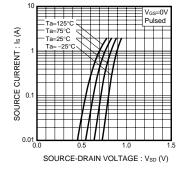


Fig.7 Reverse Drain Current vs. Source-Drain Current

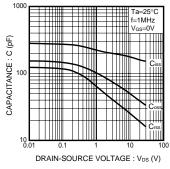


Fig.8 Typical Capacitance vs. Drain-Source Voltage

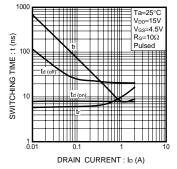
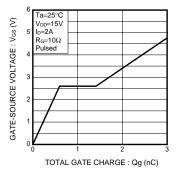
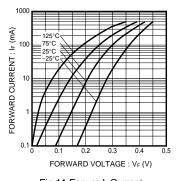


Fig.9 Switching Characteristics





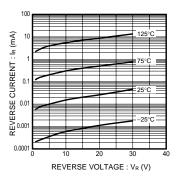


Fig.10 Dynamic Input Characteristics

Fig.11 Forward Current vs. Forward Voltage

Fig.12 Reverse Current vs. Reverse Voltage

Measurement circuits

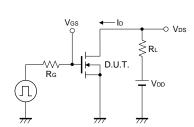


Fig.13 Switching Time Measurement Circuit

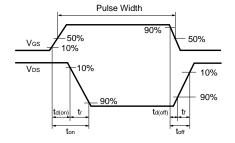


Fig.14 Switching Waveforms

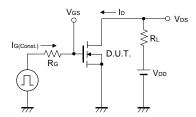


Fig.15 Gate Charge Measurement Circuit

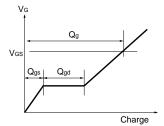


Fig.16 Gate Charge Waveform

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